

MC14504B

Hex Level Shifter for TTL to CMOS or CMOS to CMOS

The MC14504B is a hex non-inverting level shifter using CMOS technology. The level shifter will shift a TTL signal to CMOS logic levels for any CMOS supply voltage between 5 and 15 volts. A control input also allows interface from CMOS to CMOS at one logic level to another logic level: Either up or down level translating is accomplished by selection of power supply levels V_{DD} and V_{CC} . The V_{CC} level sets the input signal levels while V_{DD} selects the output voltage levels.

Features

- UP Translates from a Low to a High Voltage or DOWN Translates from a High to a Low Voltage
- Input Threshold Can Be Shifted for TTL Compatibility
- No Sequencing Required on Power Supplies or Inputs for Power Up or Power Down
- 3 to 18 Vdc Operation for V_{DD} and V_{CC}
- Diode Protected Inputs to V_{SS}
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- These Devices are Pb-Free and are RoHS Compliant
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage Range	-0.5 to +18.0	V
V_{DD}	DC Supply Voltage Range	-0.5 to +18.0	V
V_{in}	Input Voltage Range (DC or Transient)	-0.5 to +18.0	V
V_{out}	Output Voltage Range (DC or Transient)	-0.5 to $V_{DD} + 0.5$	V
I_{in}, I_{out}	Input or Output Current (DC or Transient) per Pin	± 10	mA
P_D	Power Dissipation, per Package (Note 1)	500	mW
T_A	Ambient Temperature Range	-55 to +125	°C
T_{stg}	Storage Temperature Range	-65 to +150	°C
T_L	Lead Temperature (8-Second Soldering)	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Temperature Derating:

Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

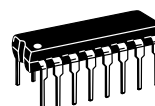
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.



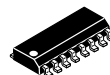
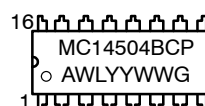
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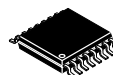
MARKING DIAGRAMS



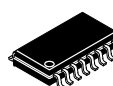
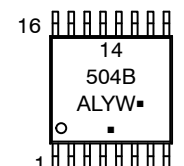
PDIP-16
P SUFFIX
CASE 648



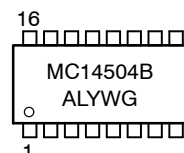
SOIC-16
D SUFFIX
CASE 751B



TSSOP-16
DT SUFFIX
CASE 948F



SOEIAJ-16
F SUFFIX
CASE 966



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or ■ = Pb-Free Indicator

(Note: Microdot may be in either location)

ORDERING INFORMATION

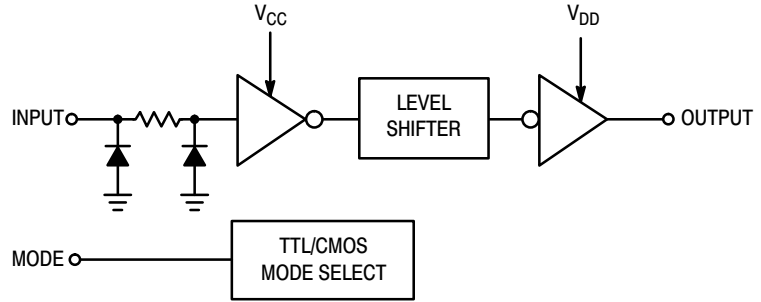
See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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PIN ASSIGNMENT

V _{CC}	1	16	V _{DD}
A _{out}	2	15	F _{out}
A _{in}	3	14	F _{in}
B _{out}	4	13	MODE
B _{in}	5	12	E _{out}
C _{out}	6	11	E _{in}
C _{in}	7	10	D _{out}
V _{SS}	8	9	D _{in}

LOGIC DIAGRAM



Mode Select	Input Logic Levels	Output Logic Levels
1 (V _{CC})	TTL	CMOS
0 (V _{SS})	CMOS	CMOS

1/6 of package shown.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC14504BCPG	PDIP-16 (Pb-Free)	500 Units / Rail
MC14504BDG	SOIC-16 (Pb-Free)	48 Units / Rail
NLV14504BDG*		
MC14504BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14504BDR2G*		
MC14504BDTG	TSSOP-16 (Pb-Free)	96 Units / Rail
NLV14504BDTG*		
MC14504BDTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel
NLV14504BDTR2G*		
MC14504BFG	SOEIAJ-16 (Pb-Free)	50 Units / Rail
MC14504BFELG	SOEIAJ-16 (Pb-Free)	2000 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V _{CC} Vdc	V _{DD} Vdc	- 55°C		25°C			125°C		Unit
				Min	Max	Min	Typ (Note 2)	Max	Min	Max	
Output Voltage V _{in} = 0 V V _{in} = V _{CC}	“0” Level V _{OL}	–	5.0	–	0.05	–	0	0.05	–	0.05	Vdc
		–	10	–	0.05	–	0	0.05	–	0.05	
		–	15	–	0.05	–	0	0.05	–	0.05	
	“1” Level V _{OH}	–	5.0	4.95	–	4.95	5.0	–	4.95	–	Vdc
		–	10	9.95	–	9.95	10	–	9.95	–	
		–	15	14.95	–	14.95	15	–	14.95	–	
Input Voltage “0” Level (V _{OL} = 1.0 Vdc) TTL–CMOS (V _{OL} = 1.5 Vdc) TTL–CMOS (V _{OL} = 1.0 Vdc) CMOS–CMOS (V _{OL} = 1.5 Vdc) CMOS–CMOS (V _{OL} = 1.5 Vdc) CMOS–CMOS	V _{IL}	5.0	10	–	0.8	–	1.3	0.8	–	0.8	Vdc
		5.0	15	–	0.8	–	1.3	0.8	–	0.8	
		5.0	10	–	1.5	–	2.25	1.5	–	1.4	
		5.0	15	–	1.5	–	2.25	1.5	–	1.5	
		10	15	–	3.0	–	4.5	3.0	–	2.9	
		–	–	–	–	–	–	–	–	–	
Input Voltage “1” Level (V _{OH} = 9.0 Vdc) TTL–CMOS (V _{OH} = 13.5 Vdc) TTL–CMOS (V _{OH} = 9.0 Vdc) CMOS–CMOS (V _{OH} = 13.5 Vdc) CMOS–CMOS (V _{OH} = 13.5 Vdc) CMOS–CMOS	V _{IH}	5.0	10	2.0	–	2.0	1.5	–	2.0	–	Vdc
		5.0	15	2.0	–	2.0	1.5	–	2.0	–	
		5.0	10	3.6	–	3.5	2.75	–	3.5	–	
		5.0	15	3.6	–	3.5	2.75	–	3.5	–	
		10	15	7.1	–	7.0	5.5	–	7.0	–	
		–	–	–	–	–	–	–	–	–	
Output Drive Current (V _{OH} = 2.5 Vdc) Source (V _{OH} = 4.6 Vdc) (V _{OH} = 9.5 Vdc) (V _{OH} = 13.5 Vdc) (V _{OL} = 0.4 Vdc) Sink (V _{OL} = 0.5 Vdc) (V _{OL} = 1.5 Vdc)	I _{OH}	–	5.0	–3.0	–	–2.4	–4.2	–	–1.7	–	mAdc
		–	5.0	–0.64	–	–0.51	–0.88	–	–0.36	–	
		–	10	–1.6	–	–1.3	–2.25	–	–0.9	–	
		–	15	–4.2	–	–3.4	–8.8	–	–2.4	–	
	I _{OL}	–	5.0	0.64	–	0.51	0.88	–	0.36	–	mAdc
		–	10	1.6	–	1.3	2.25	–	0.9	–	
		–	15	4.2	–	3.4	8.8	–	2.4	–	
Input Current	I _{in}	–	15	–	± 0.1	–	± 0.00001	± 0.1	–	± 1.0	μAdc
Input Capacitance (V _{in} = 0)	C _{in}	–	–	–	–	–	5.0	7.5	–	–	pF
Quiescent Current (Per Package) CMOS–CMOS Mode	I _{DD} or I _{CC}	–	5.0	–	0.05	–	0.0005	0.05	–	1.5	μAdc
		–	10	–	0.10	–	0.0010	0.10	–	3.0	
		–	15	–	0.20	–	0.0015	0.20	–	6.0	
Quiescent Current (Per Package) TTL–CMOS Mode	I _{DD}	5.0	5.0	–	0.5	–	0.0005	0.5	–	3.8	μAdc
		5.0	10	–	1.0	–	0.0010	1.0	–	7.5	
		5.0	15	–	2.0	–	0.0015	2.0	–	15	
Quiescent Current (Per Package) TTL–CMOS Mode	I _{CC}	5.0	5.0	–	5.0	–	2.5	5.0	–	6.0	mAdc
		5.0	10	–	5.0	–	2.5	5.0	–	6.0	
		5.0	15	–	5.0	–	2.5	5.0	–	6.0	

2. Data labelled “Typ” is not to be used for design purposes but is intended as an indication of the IC’s potential performance.

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SWITCHING CHARACTERISTICS ($C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$)

Characteristic	Symbol	Shifting Mode	V _{CC} Vdc	V _{DD} Vdc	Limits			Unit	
					Min	Typ (Note 3)	Max		
Propagation Delay, High to Low	t _{PHL}	TTL – CMOS	5.0	10	–	140	280	ns	
		V _{DD} > V _{CC}	5.0	15	–	140	280		
		CMOS – CMOS	5.0	10	–	120	240		
			V _{DD} > V _{CC}	5.0	15	–	120		240
			10	15	–	70	140		
		CMOS – CMOS	10	5.0	–	185	370		
V _{CC} > V _{DD}	15		5.0	–	185	370			
15	10		–	175	350				
Propagation Delay, Low to High	t _{PLH}	TTL – CMOS	5.0	10	–	170	340	ns	
		V _{DD} > V _{CC}	5.0	15	–	160	320		
		CMOS – CMOS	5.0	10	–	170	340		
			V _{DD} > V _{CC}	5.0	15	–	170		340
			10	15	–	100	200		
		CMOS – CMOS	10	5.0	–	275	550		
V _{CC} > V _{DD}	15		5.0	–	275	550			
15	10		–	145	290				
Output Rise and Fall Time	t _{TLH} , t _{THL}	ALL	–	5.0	–	100	200	ns	
		–	–	10	–	50	100		
		–	–	15	–	40	80		

3. Data labelled “Typ” is not to be used for design purposes but is intended as an indication of the IC’s potential performance.

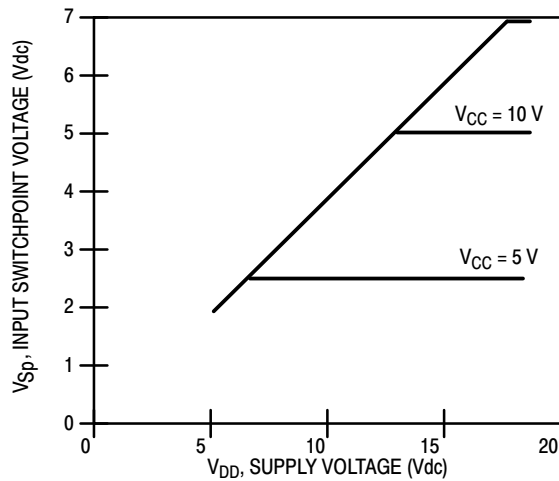


Figure 1. Input Switchpoint CMOS to CMOS Mode

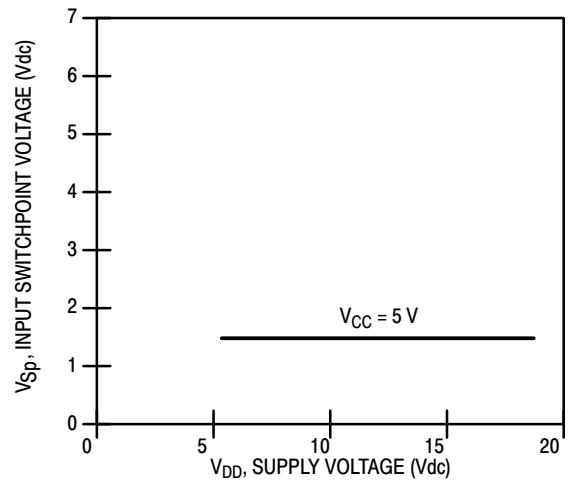


Figure 2. Input Switchpoint TTL to CMOS Mode

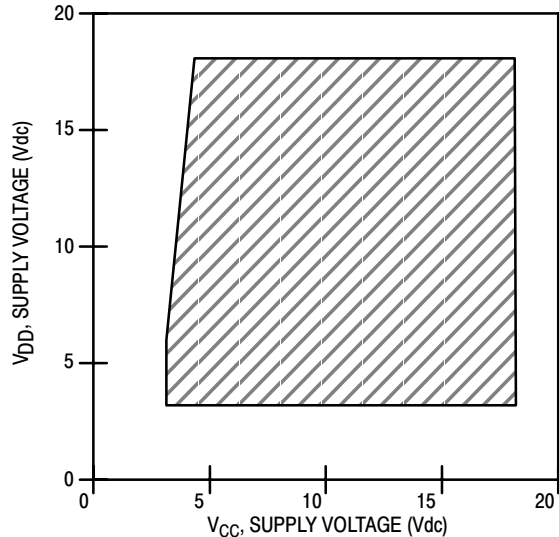


Figure 3. Operating Boundary CMOS to CMOS Mode

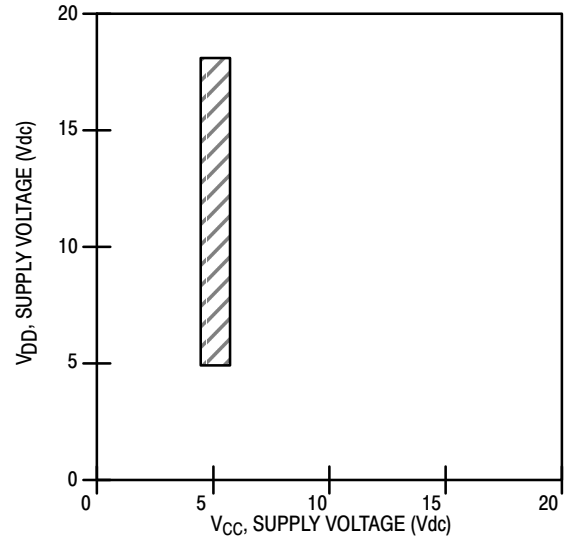
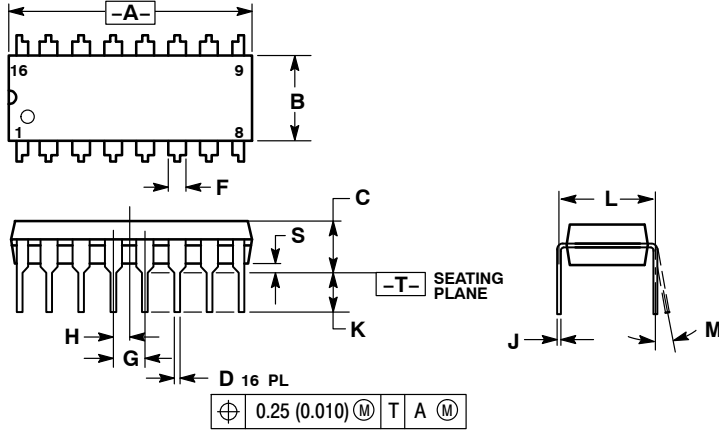


Figure 4. Operating Boundary TTL to CMOS Mode

MC14504B

PACKAGE DIMENSIONS

PDIP-16
P SUFFIX
PLASTIC DIP PACKAGE
CASE 648-08
ISSUE T

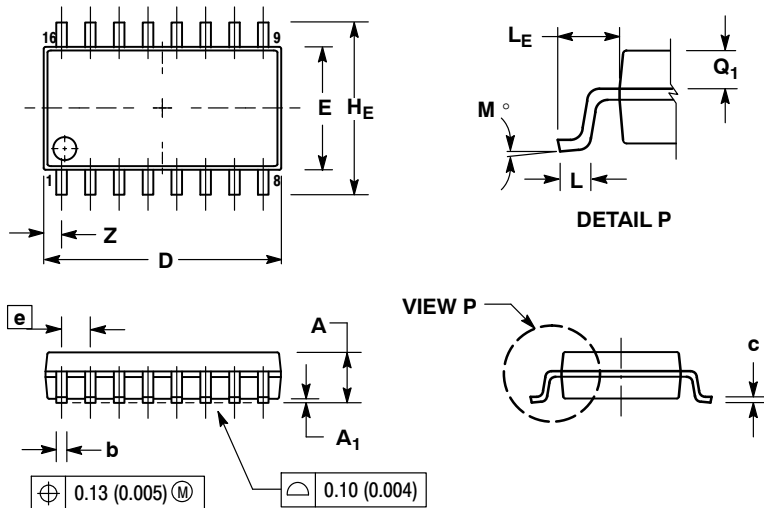


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

SOEIAJ-16
F SUFFIX
PLASTIC EIAJ SOIC PACKAGE
CASE 966-01
ISSUE A



NOTES:

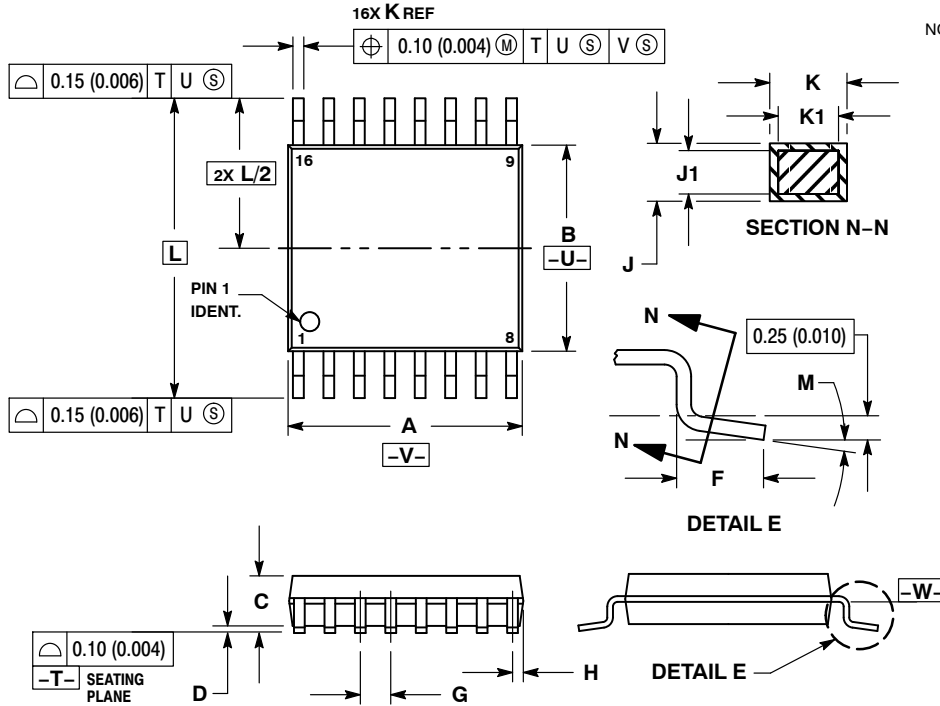
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H _E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L _E	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q ₁	0.70	0.90	0.028	0.035
Z	---	0.78	---	0.031

MC14504B

PACKAGE DIMENSIONS

TSSOP-16
DT SUFFIX
 PLASTIC TSSOP PACKAGE
 CASE 948F-01
 ISSUE B

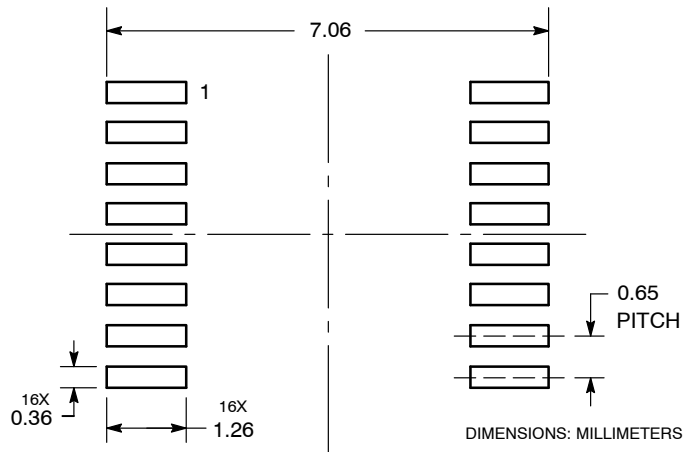


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026	BSC
H	0.18	0.28	0.007	0.011
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40	BSC	0.252	BSC
M	0°	8°	0°	8°

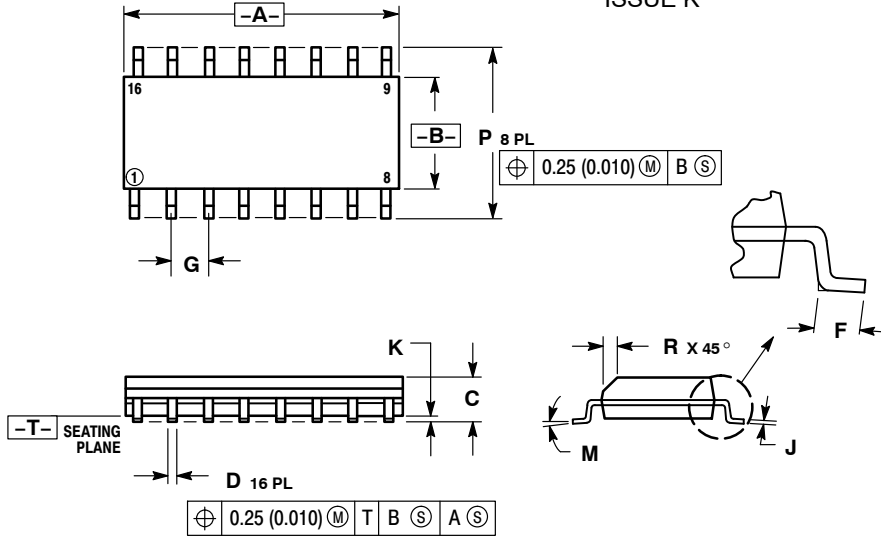
SOLDERING FOOTPRINT



MC14504B

PACKAGE DIMENSIONS

SOIC-16 D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 ISSUE K

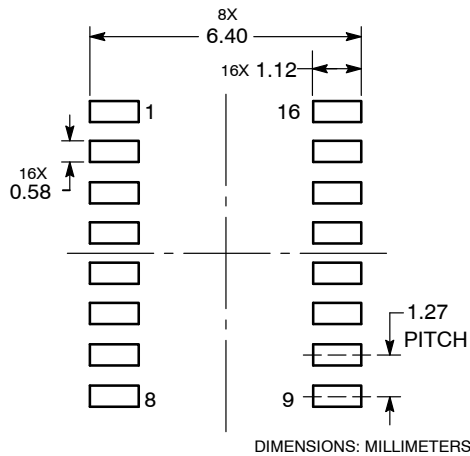


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

SOLDERING FOOTPRINT



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